

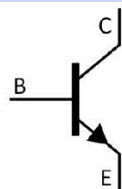
/ Descriptions

SOT-23 NPN

/ Features

/ Applications

/ Equivalent Circuit



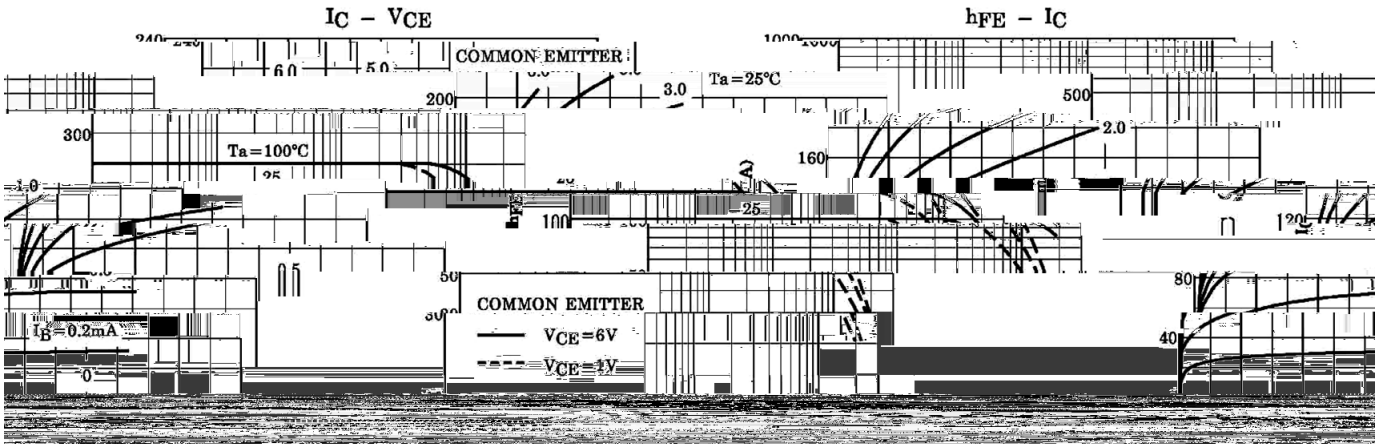
/ Pinning



/ h_{FE} Classifications & Marking

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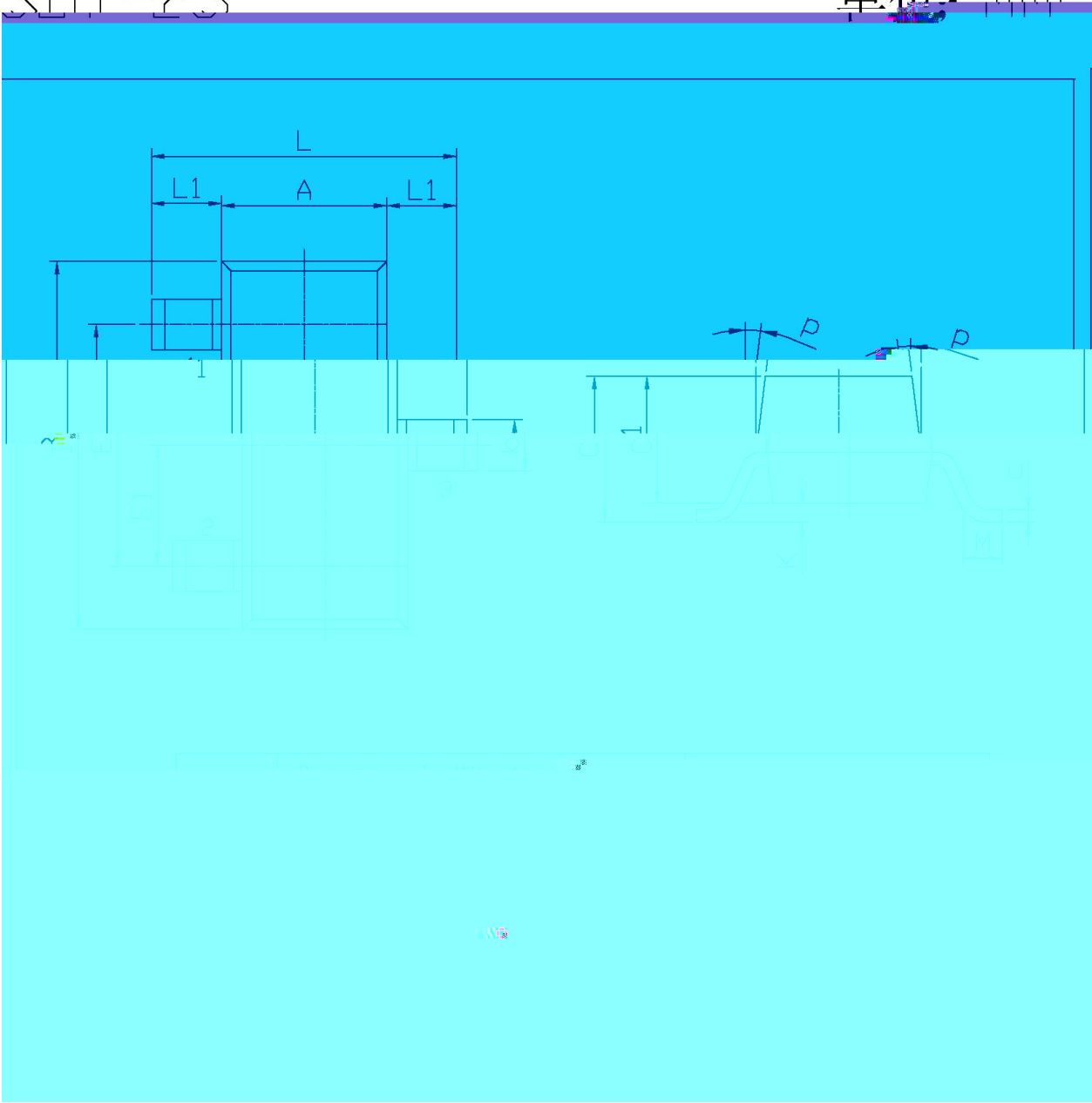
/ Electrical Characteristic Curve



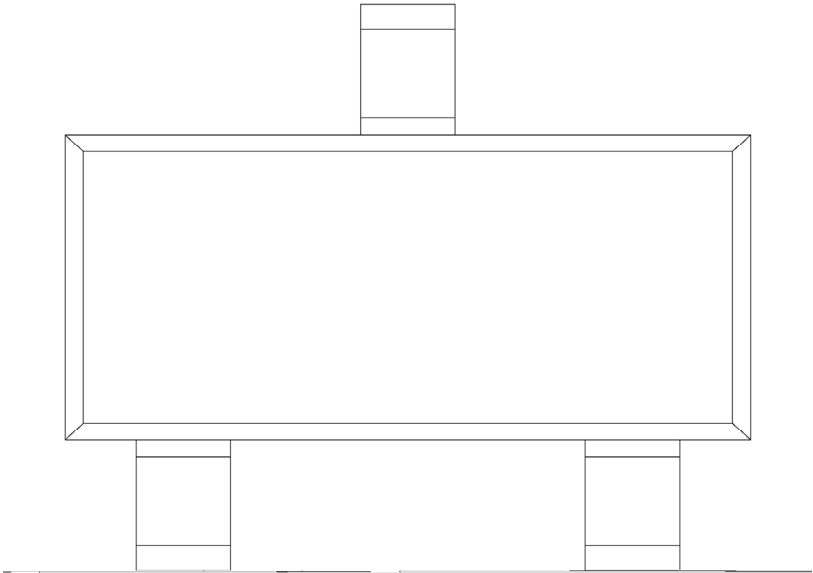
/ Package Dimensions

SOT-23

单位: mm



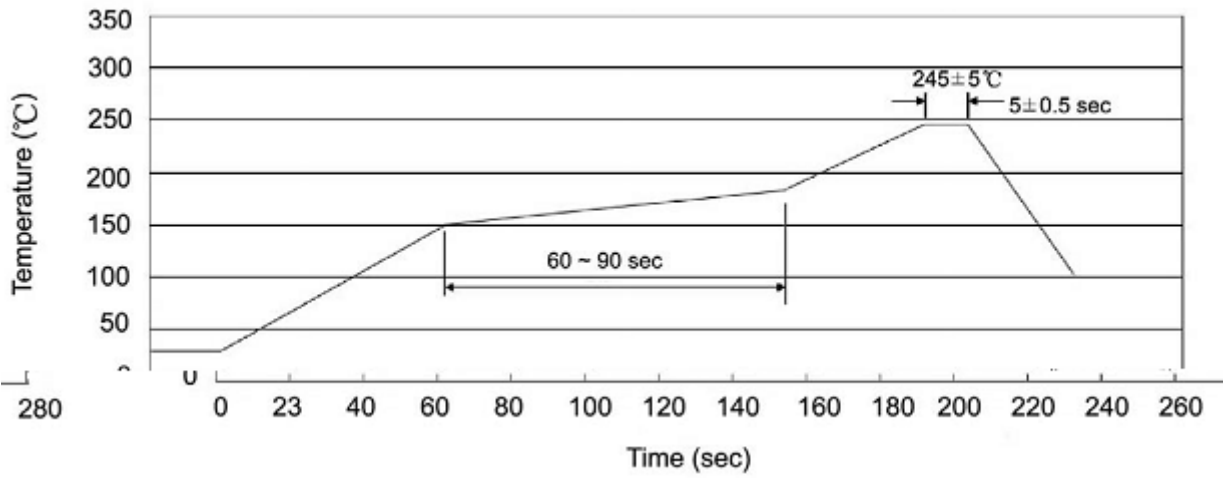
/ Marking Instructions



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() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱
						"		

/ Notices